## **HAT2045T**

## Silicon N Channel Power MOS FET High Speed Power Switching

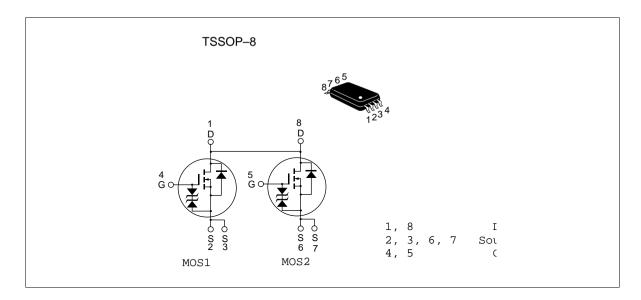
# **HITACHI**

Target Specification 5th. Edition February 1999

### **Features**

- Low on-resistance
- Capable of 2.5 V gate drive
- Low drive current
- High density mounting

### Outline





## **HAT2045T**

### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{ exttt{DSS}}$	28	V
Gate to source voltage	$V_{GSS}$	±12	V
Drain current	I <sub>D</sub>	6.0	A
Drain peak current	Note1 D(pulse)	48	A
Body-drain diode reverse drain current	I <sub>DR</sub>	6.0	A
Channel dissipation	Pch Note2	1.0	W
Channel dissipation	Pch Note3	1.5	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note: 1. PW  $\leq$  10 $\mu$ s, duty cycle  $\leq$  1 %

- 2. 1 Drive operation; When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW  $\leq$  10s
- 3. 2 Drive operation; When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW  $\leq$  10s

## **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

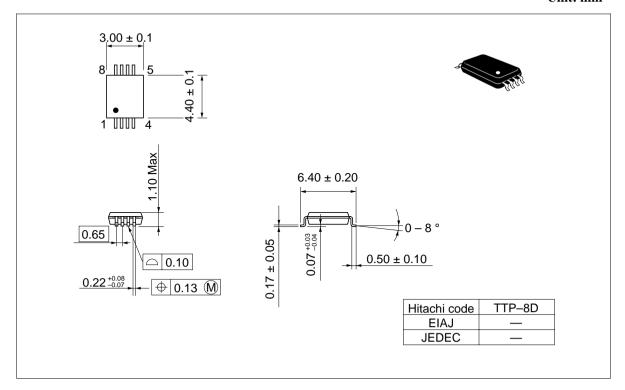
Item	Symbol	Min	Тур	Max	Unit	<b>Test Conditions</b>
Drain to source breakdown voltage	$V_{(BR)DSS}$	28	_	_	V	$I_{D} = 10 \text{mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±12	_	_	V	$I_{G} = \pm 100 \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 10V, V_{DS} = 0$
Zero gate voltege drain current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 28 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	0.4	_	1.4	V	$V_{DS} = 10V$ , $I_D = 1mA$
Static drain to source on state	$R_{\text{DS(on)}}$	_	0.020	0.025	Ω	$I_D = 3A$ , $V_{GS} = 4V^{Note4}$
resistance	R <sub>DS(on)</sub>	_	0.027	0.037	Ω	$I_D = 3A, V_{GS} = 2.5V^{Note4}$
Forward transfer admittance	$ y_{fs} $	8	13	_	S	$I_{\rm D} = 3A, V_{\rm DS} = 10V^{\rm Note4}$
Input capacitance	Ciss	_	680	_	pF	V <sub>DS</sub> = 10V
Output capacitance	Coss	_	240	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	170	_	pF	f = 1MHz
Turn-on delay time	t <sub>d(on)</sub>	_	12	_	ns	$V_{GS} = 4V$ , $I_D = 3A$
Rise time	t <sub>r</sub>	_	110	_	ns	$V_{DD} \cong 10V$
Turn-off delay time	t <sub>d(off)</sub>	_	90	_	ns	
Fall time	t <sub>f</sub>	_	100	_	ns	
Body-drain diode forward voltage	$V_{DF}$	_	0.85	1.1	V	IF =6.0A, $V_{GS} = 0^{Note4}$
Body-drain diode reverse recovery time	t <sub>rr</sub>	_	40	_	ns	$IF = 6.0A, V_{GS} = 0$ diF/ dt =20A/ $\mu$ s

Note: 4. Pulse test

## **HAT2045T**

### **Package Dimensions**

Unit: mm



#### **Cautions**

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